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Appl. No. 10/807/157
Amendment dated: November 29, 2006
Reply to OA of: August 29, 2006

This listing of claims will replace all prior versions and listings of claims in the application.

Listing of Claims:

Claims 1-5(canceled).

6(currently amended). Ceramic powder having a perovskite structure, which is obtained by [[the]] a manufacturing method ~~of claim 1 or 2~~ comprising synthesizing ceramic powder by a non-wet synthesis method and heat-treating the synthesized ceramic powder in a solution,

wherein the ceramic powder has a crystal lattice of a tetragonal system; particles of the ceramic powder are equal to or less than 0.2 μm; a c/a axial ratio of the crystal lattice is equal to or greater than 1.006; and a ratio of area occupied by holes in a single particle of the ceramic powder is equal to or less than 5%, and

wherein a particle diameter distribution of the ceramic powder is less than 30%, the particle diameter distribution being standard deviation/mean diameter of particles.

7(currently amended). Ceramic powder having a perovskite structure, which is obtained by [[the]] a manufacturing method ~~of claim 1 or 2~~ comprising synthesizing ceramic powder by a non-wet synthesis method and heat-treating the synthesized ceramic powder in a solution,

wherein the ceramic powder has a crystal lattice of a cubic system; particles of the ceramic powder is equal to or less than 0.2 μm; a full-width at half-maximum (FWHM) of an X-ray diffraction (XRD) (111) peak of the crystal lattice is equal to or smaller than 0.270°; and a ratio of area occupied by holes in a single particle of the ceramic powder is equal to or less than 5%, and

wherein a particle diameter distribution of the ceramic powder is less than 30%, the particle diameter distribution being standard deviation/ mean diameter of particles.

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Claim 8(canceled).

9(currently amended). Ceramic powder having a perovskite structure, wherein the ceramic powder has a crystal lattice of a tetragonal system; particles of the ceramic powder are equal to or less than 0.2 μm; a c/a axial ratio of the crystal lattice is equal to or greater than 1.006; and a ratio of area occupied by holes in a single particle of the ceramic powder is equal to or less than 5%, and

wherein a particle diameter distribution of the ceramic powder is less than 30%, the particle diameter distribution being standard deviation/ mean diameter of particles.

10(currently amended). Ceramic powder having a perovskite structure, wherein the ceramic powder has a crystal lattice of a cubic system; particles of the ceramic powder is equal to or less than 0.2 μm; a full-width at half-maximum (FWHM) of an X-ray diffraction (XRD) (111) peak of the crystal lattice is equal to or smaller than 0.270°; and a ratio of area occupied by holes in a single particle of the ceramic powder is equal to or less than 5%, and

wherein a particle diameter distribution of the ceramic powder is less than 30%, the particle diameter distribution being standard deviation/ mean diameter of particles.

Claim 11(canceled).

12(original). Ceramic electronic component comprising a dielectric portion made of the ceramic powder of claim 9 or 10.

13(original). A method for manufacturing a ceramic electronic component comprising the step of forming a dielectric portion by employing the ceramic powder of claim 9 or 10.

14(original). A multi-layer ceramic capacitor comprising:

a dielectric portion made of the ceramic powder of claim 9 or 10;

a plurality of internal electrodes whose edges are alternately exposed at two surfaces of the dielectric portion; and

a pair of external electrodes formed at surfaces of the dielectric portion to be connected to the exposed edges of the internal electrodes.

Claim 15 (canceled).